

C147A-C147PB

SILICON CONTROLLED RECTIFIERS

FEATURES

- Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.
- Available as non-RoHS (Sn/Pb plating), standard, and as RoHS by adding "-PBF" suffix.

MAXIMUM RATINGS

Part number	Repetitive peak off-state voltage	Repetitive peak reverse voltage	Non-repetitive peak reverse voltage	Units
	V_{DRM}^1	V_{RRM}^1	V_{RSM}^1	
	$T_J = -40^\circ \text{ to } 125^\circ \text{C}$	$T_J = -40^\circ \text{C to } 125^\circ \text{C}$	$T_J = 125^\circ \text{C}$	
C147A	100	100	150	V
C147B	200	200	300	V
C147C	300	300	400	V
C147D	400	400	500	V
C147E	500	500	600	V
C147M	600	600	720	V
C147S	700	700	840	V
C147N	800	800	960	V
C147T	900	900	1080	V
C147P	1000	1000	1200	V
C147PA	1100	1100	1320	V
C147PB	1200	1200	1440	V

1: Pulse width: half sine wave waveform, 10 msec.

Rating	Symbol	Value	Unit
RMS on-state current (All conduction angles)	$I_{T(RMS)}$	63	A
Average on-state current	$I_{T(AV)}$	Figures 2 and 3	
Critical rate of rise of on-state current (non-repetitive) Switching from 1200V Switching from 600V	di/dt	100 200	A/ μ s
Peak one cycle surge (non-repetitive) on-state current 60Hz 50Hz	I_{TSM}	1000 910	A
Fusing Times ≥ 8.3 ms Times ≥ 1.5 ms	I^2t	4150 2850	A ² s
Peak gate power dissipation for 150μs	P_{GM}	100	W
Average gate power dissipation	$P_{G(AV)}$	2	W
Storage temperature	T_{stg}	-40 to 150	$^\circ$ C
Operating temperature	T_J	-40 to 125	$^\circ$ C
Maximum stud torque		3-4	N-m

di/dt ratings for conditions of V_{DRM} stated above; 20V, 20 Ω gate trigger source with 0.5 μ sec short circuit trigger current rise time.

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ELECTRICAL CHARACTERISTICS

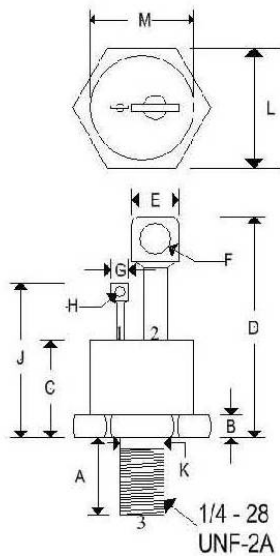
Characteristic	Symbol	Min	Max	Units	Test Condition
Peak off-state and reverse current	I_{DRM} , I_{RRM}	-	12	mA	$T_J = -40$ to 125°C $V_{DRM} = V_{RRM} =$
C147A					100 Volts peak
C147B					200 Volts peak
C147C					300 Volts peak
C147D					400 Volts peak
C147E					500 Volts peak
C147M					600 Volts peak
C147S					700 Volts peak
C147N					800 Volts peak
C147T					900 Volts peak
C147P					1000 Volts peak
C147PA					1100 Volts peak
C147PB					1200 Volts peak
DC gate trigger current	I_{GT}	-	150	mAdc	$T_C = 25^{\circ}\text{C}$, $V_D = 12\text{Vdc}$, $R_L = 12\text{ohms}$
		-	300		$T_C = -40^{\circ}\text{C}$, $V_D = 12\text{Vdc}$, $R_L = 12\text{ohms}$
DC gate trigger voltage	V_{GT}	-	3	Vdc	$T_C = 25^{\circ}\text{C}$, $V_D = 12\text{Vdc}$, $R_L = 12\text{ohms}$
		-	3.5		$T_C = -40^{\circ}\text{C}$, $V_D = 12\text{Vdc}$, $R_L = 12\text{ohms}$
		0.25	-		$T_C = 125^{\circ}\text{C}$, rated V_{DRM} , $R_L = 1000\text{ohms}$
Peak on-state voltage	V_{TM}	-	3	V	$T_C = 25^{\circ}\text{C}$, $I_{TM} = 500\text{A(pk)}$, 1ms wide pulse, duty cycle $\leq 1\%$
Holding current	I_H	-	250	mAdc	$T_C = 25^{\circ}\text{C}$ anode supply = 24Vdc, gate supply = 10V/20ohms. Initial forward pulse = 2A, 0.1 ms to 10 ms wide
Critical rate of rise of off-state voltage (higher values may cause device switching)	dv/dt	200	-	V/ μs	$T_C = 125^{\circ}\text{C}$, rated V_{DRM} , using linear exponential rising waveform, gate open circuited Exponential $dv/dt = V_{DRM} / \tau$ (0.632)
Thermal resistance	$R_{\theta JC}$	-	0.35	$^{\circ}\text{C/W}$	Junction to case
Typical turn-off time	t_q	125		μsec	1) $T_J = 125^{\circ}\text{C}$ 2) $I_{TM} = 150\text{A}$, peak 3) $V_R = 50\text{V}$, min 4) V_{DRM} (reapplied) 5) Rate-of-rise of reapplied off state voltage = 20V/ μsec (linear) 6) Commutation $di/dt = 5\text{A}/\mu\text{sec}$ 7) Repetition rate = 1PPS 8) Gate bias during turn-off interval = 0V, 100 Ω

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MECHANICAL CHARACTERISTICS

Case	TO-65
Marking	Alpha-numeric
Pin out	See below

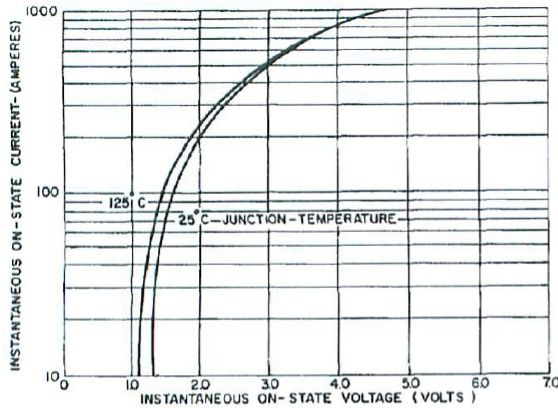


Pin 1: Gate
Pin 2: Cathode
Pin 3: Anode

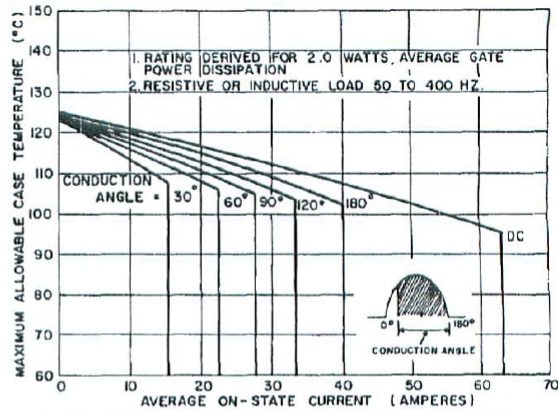
	TO-65			
	Inches		Millimeters	
	Min	Max	Min	Max
A	0.422	0.452	10.720	11.470
B	0.120	0.135	3.050	3.420
C	0.534	0.565	13.570	14.340
D	1.230	1.290	31.250	32.780
E	0.240	0.300	6.100	7.620
F	0.169	0.182	4.300	4.620
G	0.090	0.115	2.290	2.910
H	0.055	0.066	1.400	1.670
J	0.831	0.901	21.110	22.880
K	0.220	-	5.590	-
L	0.676	0.684	17.180	17.360
M	-	0.597	-	15.150

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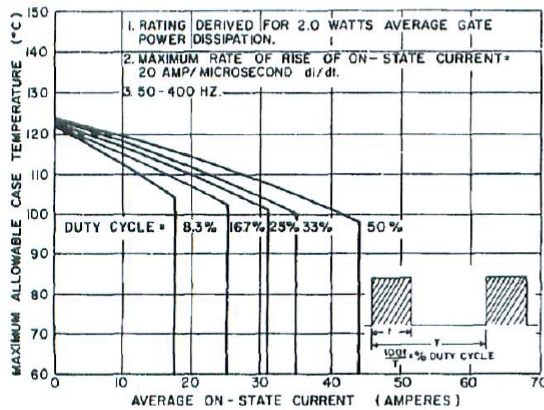
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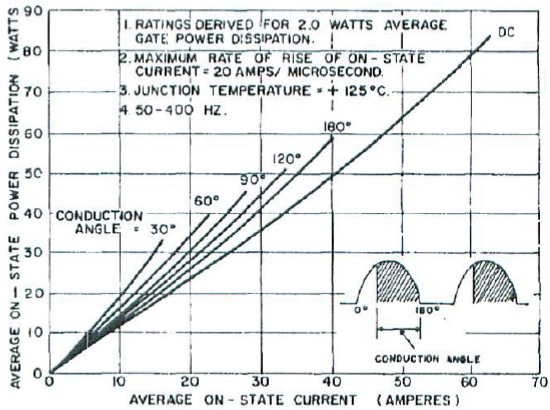
1. MAXIMUM ON-STATE CHARACTERISTICS



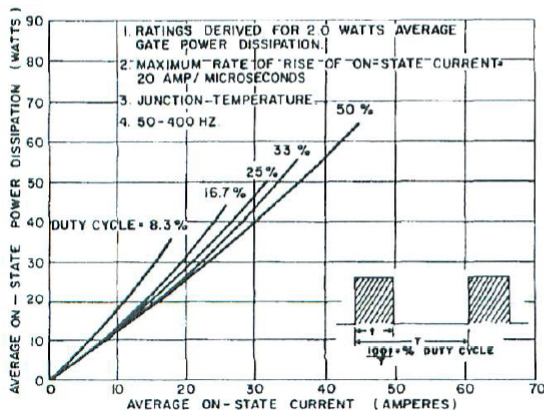
2. MAXIMUM ALLOWABLE CASE TEMPERATURE FOR SINUSOIDAL CURRENT WAVEFORM



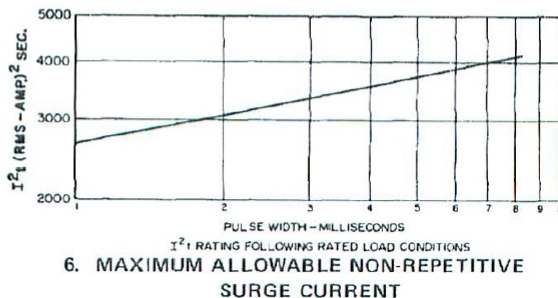
3. MAXIMUM ALLOWABLE CASE TEMPERATURE FOR RECTANGULAR CURRENT WAVEFORM



4. MAXIMUM ON-STATE POWER DISSIPATION FOR SINUSOIDAL CURRENT WAVEFORM



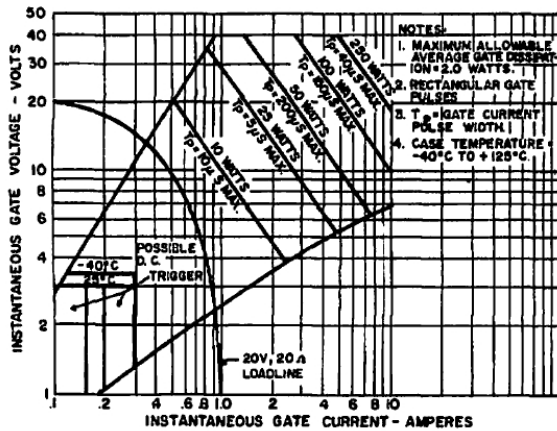
5. MAXIMUM ON-STATE POWER DISSIPATION FOR RECTANGULAR CURRENT WAVEFORM



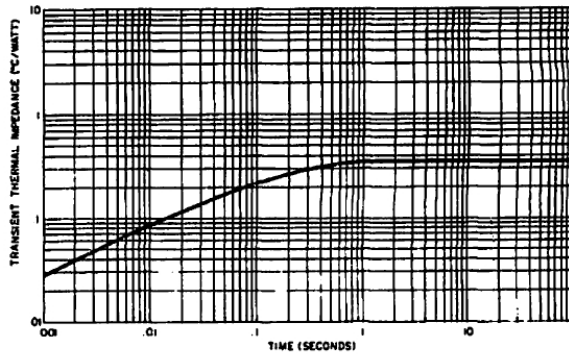
6. MAXIMUM ALLOWABLE NON-REPETITIVE SURGE CURRENT

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7. GATE TRIGGER CHARACTERISTICS AND POWER RATINGS



8. TRANSIENT THERMAL IMPEDANCE — JUNCTION-TO-CASE